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SURFACE MOUNT SILICON N-CHANNEL ENHANCEMENT-MODE MOSFET



• Device is Halogen Free by design

APPLICATIONS:

Load/Power Switches

Power Supply Converter Circuits

• Battery Powered Portable Equipment



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DESCRIPTION:

The CENTRAL SEMICONDUCTOR CTLDM7003-M621 is a silicon N-Channel enhancement-mode MOSFET in a small, thermally efficient, TLM^m 2x1mm package.

MARKING CODE: CS

FEATURES:

- ESD Protection up to 2kV
- Low rDS(ON)
- Low Threshold Voltage
- Fast Switching
- Logic Level Compatible

• Small TLM[™] 2x1mm Package

MAXIMUM RATINGS: (T _A =25°C)	SYMBOL		UNITS
Drain-Source Voltage	V _{DS}	50	V
Drain-Gate Voltage	V _{DG}	50	V
Gate-Source Voltage	V _{GS}	12	V
Continuous Drain Current	۱ _D	280	mA
Maximum Pulsed Drain Current	IDM	1.5	А
Power Dissipation (Note 1)	Ρ _D	0.9	W
Operating and Storage Junction Temperature	T _{J,} T _{stg}	-65 to +150	°C
Thermal Resistance	Θ_{JA}	139	°C/W

ELECTRICAL CHARACTERISTICS: (T_A=25°C unless otherwise noted)

SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNITS
IGSSF, IGSSR	V _{GS} =5.0V			100	nA
IGSSF, IGSSR	V _{GS} =10V			2.0	μΑ
IGSSF, IGSSR	V _{GS} =12V			2.0	μA
IDSS	V _{DS} =50V, V _{GS} =0			50	nA
BVDSS	V _{GS} =0, I _D =10μΑ	50			V
V _{GS(th)}	V _{DS} =V _{GS} , I _D =250µA	0.49		1.0	V
V _{SD}	V _{GS} =0, I _S =115mA			1.4	V
^r DS(ON)	V _{GS} =1.8V, I _D =50mA		1.6	3.0	Ω
^r DS(ON)	V _{GS} =2.5V, I _D =50mA		1.3	2.5	Ω
rDS(ON)	V _{GS} =5.0V, I _D =50mA		1.1	2.0	Ω
9FS	V _{DS} =10V, I _D =200mA	200			mS
C _{rss}	V _{DS} =25V, V _{GS} =0, f=1.0MHz			5.0	pF
C _{iss}	V _{DS} =25V, V _{GS} =0, f=1.0MHz			50	pF
C _{oss}	V _{DS} =25V, V _{GS} =0, f=1.0MHz			25	pF
Q _{g(tot)}	V_{DS} =25V, V_{GS} =4.5V, I_{D} =100mA		0.764		nC
Q _{gs}	V_{DS} =25V, V_{GS} =4.5V, I_{D} =100mA		0.148		nC
Q _{gd}	V_{DS} =25V, V_{GS} =4.5V, I_{D} =100mA		0.156		nC

Notes: (1) FR-4 Epoxy PCB with copper mounting pad area of 33mm².h

R2 (9-February 2015)





SURFACE MOUNT SILICON N-CHANNEL ENHANCEMENT-MODE MOSFET







BOTTOM VIEW R2 *Exposed pad P connects pins 1, 2, 5, and 6.

PIN CONFIGURATION



	DIMENSIONS			
SYMBOL	INCHES		MILLIMETERS	
STIVIDUL	MIN	MAX	MIN	MAX
А	0.073	0.085	1.850	2.150
В	0.033	0.045	0.850	1.150
С	0.028	0.031	0.700	0.800
D	0.006		0.150	
E	0.000	0.002	0.000	0.050
F	0.008		0.200	
G	0.010		0.250	
Н	0.020		0.500	
J	0.020		0.500	
К	0.012	0.020	0.300	0.500
L	0.007	0.012	0.180	0.300
М	0.007	0.012	0.180	0.300
N	0.007	0.012	0.180	0.300
TLM621 (REV: R2)				

SUGGESTED MOUNTING PADS (Dimensions in mm)



LEAD CODE:

- 1) Drain 2) Drain
- 3) Gate
- 4) Source
- 5) Drain
- 6) Drain

MARKING CODE: CS

R2 (9-February 2015)

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CTLDM7003-M621

SURFACE MOUNT SILICON N-CHANNEL ENHANCEMENT-MODE MOSFET



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OUTSTANDING SUPPORT AND SUPERIOR SERVICES

PRODUCT SUPPORT

Central's operations team provides the highest level of support to insure product is delivered on-time.

- Supply management (Customer portals)
- Inventory bonding
- Consolidated shipping options

DESIGNER SUPPORT/SERVICES

Central's applications engineering team is ready to discuss your design challenges. Just ask.

- Free guick ship samples (2nd day air)
- Online technical data and parametric search
- SPICE models
- Custom electrical curves
- · Environmental regulation compliance
- Customer specific screening
- · Up-screening capabilities

· Custom product packing

Custom bar coding for shipments

- Special wafer diffusions
- PbSn plating options
- Package details
- Application notes
- · Application and design sample kits
- · Custom product and package development

REQUESTING PRODUCT PLATING

- If requesting Tin/Lead plated devices, add the suffix "TIN/LEAD" to the part number when 1. ordering (example: 2N2222A TIN/LEAD).
- 2. If requesting Lead (Pb) Free plated devices, add the suffix " PBFREE" to the part number when ordering (example: 2N2222A PBFREE).

CONTACT US

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Product End of Life Notification

PDN ID:	PDN01096
Notification Date:	8/07/18
Last Buy Date:	2/07/19
Last Shipment Date	8/07/19

Summary:All devices in the TLM621 and TLM621H packages are discontinued and now classified as End of Life (EOL).

Although Central Semiconductor Corp. makes every effort to continue to produce devices that have been proclaimed EOL (End of Life) by other manufacturers, it is an accepted industry practice to discontinue certain devices when customer demand falls below a minimum level of sustainability. Accordingly, the following product(s) have been transitioned to End of Life status as part of Central's ongoing Product Management Process. Any replacement products are noted below. The effective date for placing last purchase orders will be six (6) months from the date of this notice and twelve (12) months from the notice date for final shipments, and minimum order quantities may apply. The last purchase and shipment dates may be extended if inventory is available.

Central Part Number	Replacement
CTLDM7002A-M621 BK	N/A, Stock Only
CTLDM7002A-M621 TR	N/A, Stock Only
CTLDM7003-M621 BK	N/A, Stock Only
CTLDM7003-M621 TR	N/A, Stock Only
CTLDM7120-M621H BK	N/A, Stock Only
CTLDM7120-M621H TR	N/A, Stock Only
CTLDM8002A-M621 BK	N/A, Stock Only
CTLDM8002A-M621 TR	N/A, Stock Only
CTLDM8002A-M621H BK	N/A, Stock Only
CTLDM8002A-M621H TR	N/A, Stock Only
CTLDM8120-M621H BK	N/A, Stock Only
CTLDM8120-M621H TR	N/A, Stock Only
CTLSH05-40M621 BK	N/A, Stock Only
CTLSH05-40M621 TR	N/A, Stock Only
CTLSH1-40M621H BK	N/A, Stock Only
CTLSH1-40M621H TR	N/A, Stock Only
CTLT3410-M621 BK	N/A, Stock Only
CTLT3410-M621 TR	N/A, Stock Only
CTLT7410-M621 TR	N/A, Stock Only

Central would be happy to assist you by providing additional information or technical data to help locate an alternate source if we have no replacement available. Please email your requests to engineering@centralsemi.com.

DISCLAIMER: This End of Life (EOL) notification is in accordance with JEDEC standard JESD48 - Product Discontinuance. Central Semiconductor Corp. will make every effort to offer life-time buy (LTB) opportunities and/or offer replacement devices to existing customers for discontinued devices, however, one or both may not be possible for all devices. Please contact your local Central Semiconductor sales representative for LTB opportunities/additional information.